

POWER SCHOTTKY RECTIFIER

MAIN PRODUCT CHARACTERISTICS

$I_{F(AV)}$	2 x 40 A
V_{RRM}	60 V
$T_j(\text{max})$	150 °C
$V_F(\text{max})$	0.56 V

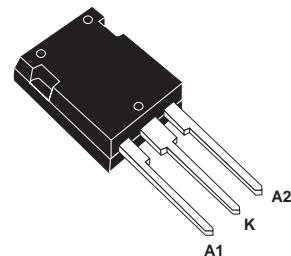
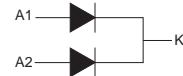
FEATURES AND BENEFITS

- VERY SMALL CONDUCTION LOSSES
- NEGLIGIBLE SWITCHING LOSSES
- EXTREMELY FAST SWITCHING
- LOW FORWARD VOLTAGE DROP
- LOW THERMAL RESISTANCE

DESCRIPTION

Dual center tap Schottky rectifier suited for CAD computers and servers.

Packaged in Max247, STPS80L60CY is intended for use in low voltage, high frequency switching power supplies, free wheeling and polarity protection applications.



Max247

ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter			Value	Unit		
V_{RRM}	Repetitive peak reverse voltage			60	V		
$I_{F(\text{RMS})}$	RMS forward current			56	A		
$I_{F(AV)}$	Average forward current	$T_c = 130^\circ\text{C}$	Per diode $\delta = 0.5$	40 80	A		
I_{FSM}	Surge non repetitive forward current			400	A		
I_{RRM}	Repetitive peak reverse current	$t_p = 2 \mu\text{s}$ square $F = 1\text{kHz}$		2	A		
T_{stg}	Storage temperature range			- 55 to + 150	°C		
T_j	Maximum operating junction temperature *			150	°C		
dV/dt	Critical rate of rise of reverse voltage			10000	V/ μs		

* : $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th}(j - a)}$ thermal runaway condition for a diode on its own heatsink

STPS80L60CY

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction to case	Per diode	0.70
		Total	0.50
$R_{th(c)}$	Coupling	0.3	

When the diodes 1 and 2 are used simultaneously :
 $\Delta T_j(\text{diode 1}) = P(\text{diode 1}) \times R_{th(j-c)}(\text{Per diode}) + P(\text{diode 2}) \times R_{th(c)}$

STATIC ELECTRICAL CHARACTERISTICS (per diode)

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
I_R^*	Reverse leakage current	$T_j = 25^\circ\text{C}$	$V_R = V_{RRM}$			1.8	mA
		$T_j = 125^\circ\text{C}$			0.4	0.9	A
V_F^*	Forward voltage drop	$T_j = 25^\circ\text{C}$	$I_F = 40 \text{ A}$			0.57	V
		$T_j = 125^\circ\text{C}$			0.50	0.56	
		$T_j = 25^\circ\text{C}$	$I_F = 80 \text{ A}$			0.78	
		$T_j = 125^\circ\text{C}$				0.69	
		$T_j = 125^\circ\text{C}$				0.77	

Pulse test : * $t_p = 380 \mu\text{s}$, $\delta < 2\%$

To evaluate the maximum conduction losses use the following equation :

$$P = 0.36 \times I_{F(AV)} + 0.005 \times I_{F(RMS)}^2$$

Fig. 1: Conduction losses versus average current.

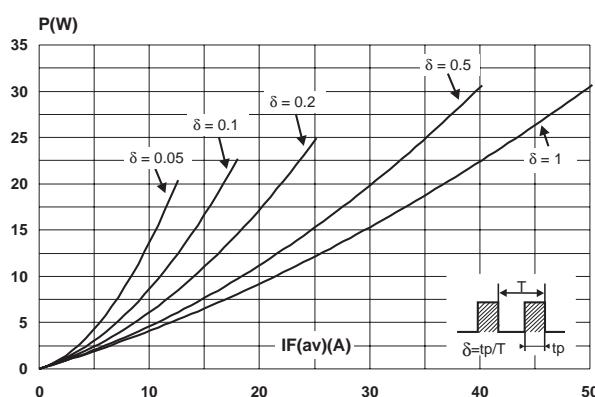


Fig. 2: Average forward current versus ambient temperature ($\delta = 0.5$).

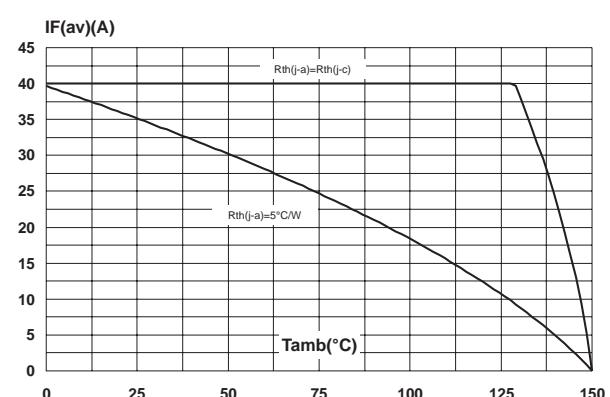


Fig. 3: Non repetitive surge peak forward current versus overload duration (maximum values).

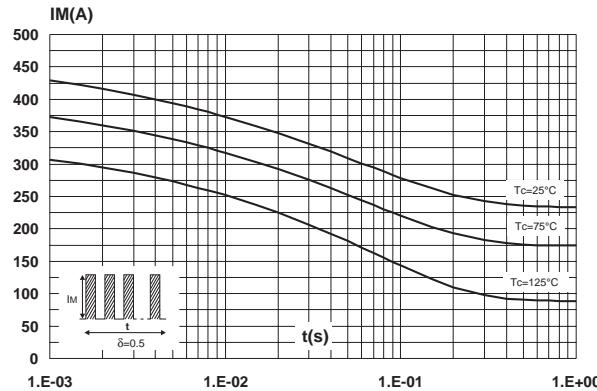


Fig. 5: Reverse leakage current versus reverse voltage applied (typical values).

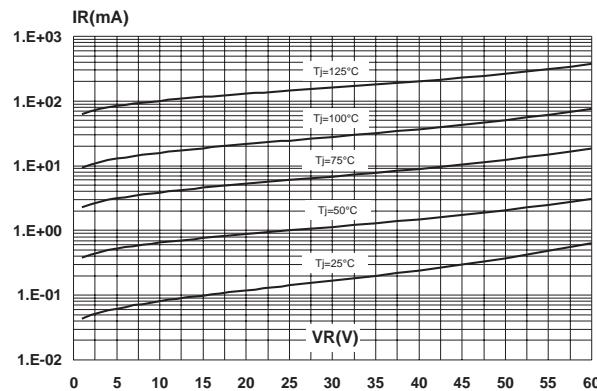


Fig. 7: Forward voltage drop versus forward current.

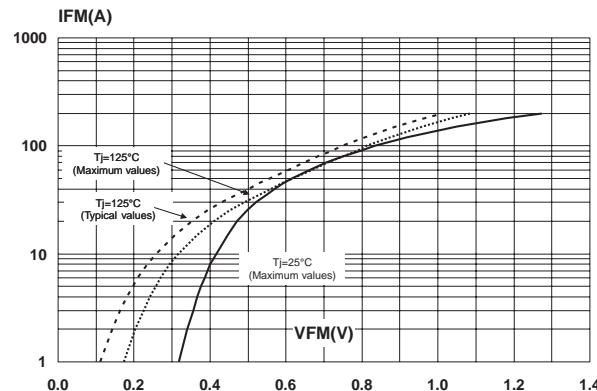


Fig. 4: Relative variation of thermal impedance junction to case versus pulse duration.

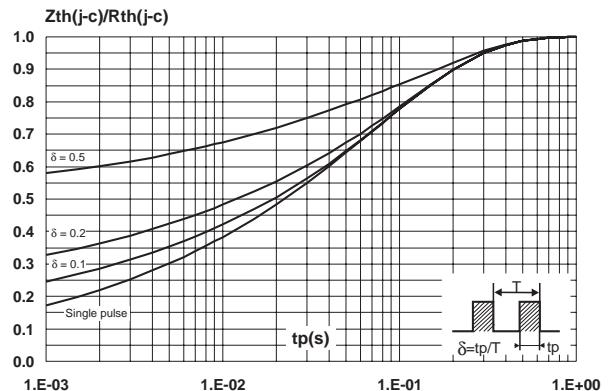
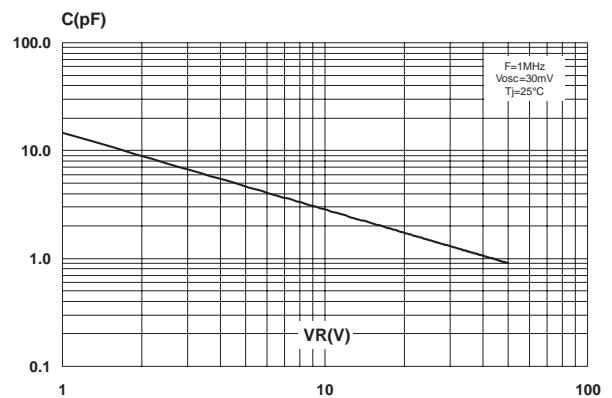


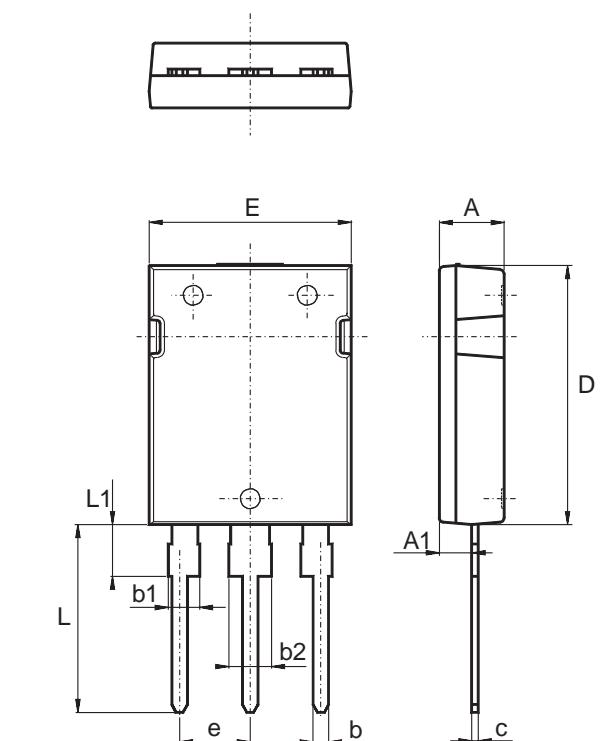
Fig. 6: Junction capacitance versus reverse voltage applied (typical values).



STPS80L60CY

PACKAGE MECHANICAL DATA

Max247



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.70	5.30	0.185	0.209
A1	2.20	2.60	0.087	0.102
b	1.00	1.40	0.038	0.055
b1	2.00	2.40	0.079	0.094
b2	3.00	3.40	0.118	0.133
c	0.40	0.80	0.016	0.031
D	19.70	10.30	0.776	0.799
e	5.35	5.55	0.211	0.219
E	15.30	15.90	0.602	0.626
L	14.20	15.20	0.559	0.598
L1	3.70	4.30	0.146	0.169

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS80L60CY	STPS80L60CY	Max247	4.4g	30	Tube

- Epoxy meets UL94,V0

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